



## Final Product Change Notification

201506009F01

**Issue Date:** 21-Jun-2015  
**Effective Date:** 03-Oct-2015

Here's your personalized quality information concerning products Digi-Key purchased from NXP.  
For detailed information we invite you to view this notification online



# QUALITY

### Management Summary

Enable Assembly & ATE-FT of the PCA9617ADP in ASEN. (Assembly was previously 'qualified' but enabling the ATE-FT step will allow for full turn-key processing).

### Change Category

<input type="checkbox"/> Wafer Fab process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab materials	<input checked="" type="checkbox"/> Assembly Materials	<input type="checkbox"/> Electrical spec./Test coverage	<input type="checkbox"/> Mechanical Specification
<input type="checkbox"/> Wafer Fab location	<input checked="" type="checkbox"/> Assembly Location	<input checked="" type="checkbox"/> Test Location	<input type="checkbox"/> Packing/Shipping/Labeling

## ASEN as an additional Assembly & Final Test Location for PCA9617ADP

### Details of this Change

NXP is going to setup a 2nd source of Assembly & Final Test in ASEN.

#### Why do we Implement this Change

As a JV and strategic partner ASEN is the logical choice for the product line to expand its turn-key solutions.

ASEN, located in Suzhou, China already supports a number of turn-key products for the PL and this addition allows for NXP and the BL to optimize assembly and test capacity by improving flexibility for production planning. Assembly was previously 'qualified' but enabling ATE-FT step will allow for full turn-key processing.

#### Identification of Affected Products

Box and Reel labels will show appropriate Country of Origin.

### Product Availability

#### Sample Information

Samples are available upon request

#### Production

Planned first shipment 10-Aug-2015

#### Impact

no impact to the product's functionality anticipated.

#### Data Sheet Revision

No impact to existing datasheet

#### Disposition of Old Products

Existing inventory will be shipped until depleted

### Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 21-Jul-2015.

## Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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